

YDA2/2A600V——2A 600V Opto-MOS

概述 Features

- 厚度3.0mm SSR Thickness 3.0mm SSR
- 交直流通用 AC&DC load
- 负载电流最大为2A Max. load current 2A
- 击穿电压600V Breakdown voltage 600V
- 介质耐压3000V Dielectric strength 3000V
- 符合RoHS RoHS compliant

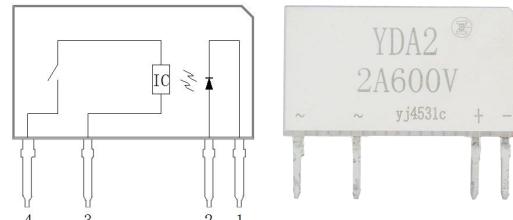


应用 Applications

- 测试设备 Measuring instruments
- 工业控制 Industrial control

打印标志 Marking information

Part number	Package	Marking
YDA2/2A600V	SIP4	YDA2 2A600V



极限值 Absolute maximum ratings

(Ta=25°C)

特性参数/Parameter		符号 /Symbol	测试条件 /Test condition	最小值 /Min.	典型值 /Typ.	最大值 /Max.	单位 /Unit
输入端 /Input	LED 反向电压/LED reverse voltage	V _R		6			V
	LED 正向电流/LED forward current	I _F				50	mA
	功耗/Power dissipation	P _{in}				75	mW
输出端 /Output	击穿电压/Breakdown voltage	BV _{DSS}		600			V
	功耗/Power dissipation	P _{out}				2	W
	额定电流/On-state current	I _L	I _{in} =10mA			2	A
	峰值电流/Peak current	I _{peak}	100 ms (1shot), VL = DC		4		A
介质耐压/Dielectric strength *		V _{ISO}	I _{ISO} ≤0.3mA	3000			V _{rms}
工作温度/Operating temperature		T _{opr}		-30		85	°C
储存温度/Storage temperature		T _{stg}		-40		125	°C

“*” : RH =40 to 60%, T=20~30°C,AC for 1 minute.

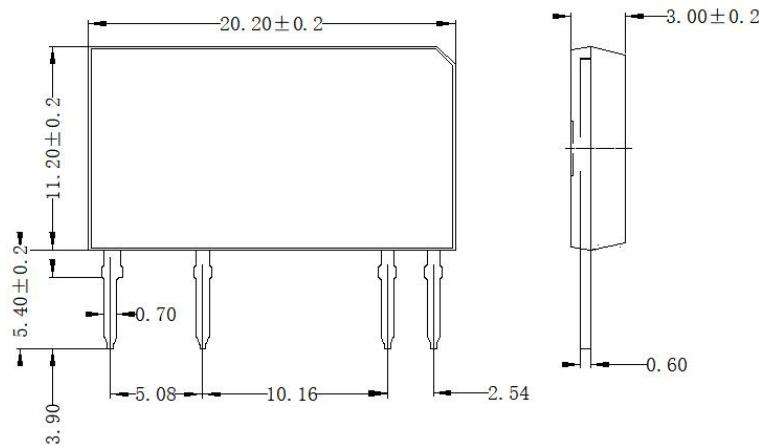
电参数 Electrical parameters

(Ta=25°C)

特性参数/Parameter		符号/Symbol	测试条件/Test condition	最小值/Min.	典型值/Typ.	最大值/Max.	单位/Unit
输入端/Input	LED 正向电压/LED forward voltage	V _f	I _f =10mA		1. 2	1. 3	V
	LED 反向电流/LED reverse current	I _r	V _r =5V			10	μA
输出端/Output	断态泄漏电流/Output off-state leakage current	I _{Leak}	V ₄₋₃ =600V			5	μA
	断态泄漏电流/Output off-state leakage current	I _{Leak}	V ₃₋₄ =600V			5	μA
耦合特性/Transfer characteristics	LED 触发电流/LED trigger current	I _{tr}			3	8	mA
	推荐的工作电流/Recommend operating current	I _{in}		10		18	mA
	导通电阻/Output on-state resistance	R _{on}	I _{in} =10mA, I _d =2A			0. 5	Ω
	导通时间/Turn on time	T _{on}	I _{in} =10mA, I _d =1. 0A			5	ms
	关断时间/Turn off time	T _{off}	I _{in} =10mA, I _d =1. 0A			2	ms
	电容/I/O capacitance	C				10	pF

外形尺寸 Outline dimension :mm

SIP4



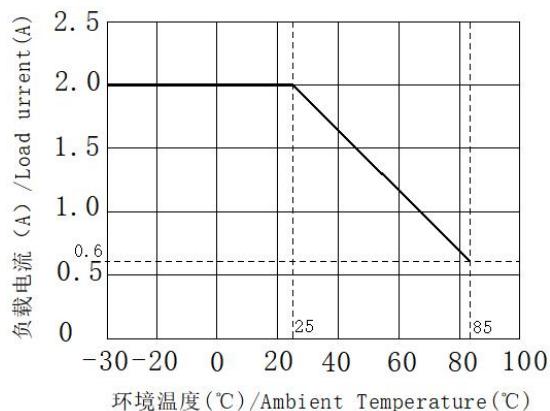
注：未标公差为±0.05mm

订货信息 Ordering information

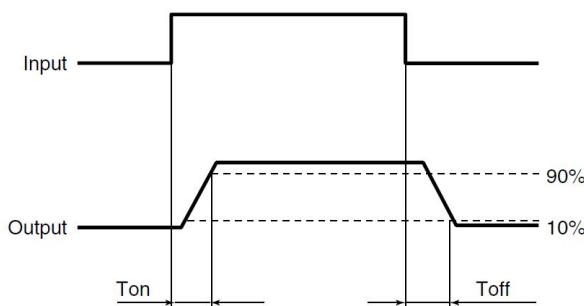
订货信息/Ordering information					
	Y	DA	2/	2A	600V
公司商标代号 Company symbol					
光功率 MOS SSR: Opto-power MOS SSR					
封装 Package: 2: SIP4					
负载电流 Load current: 2A					
击穿电压 BV _{DS} : 600V					

特性曲线 Characteristic data (推荐使用散热器 Heatsink is recommended)

1. 负载电流与环境温度关系曲线
Load current VS. ambient temperature

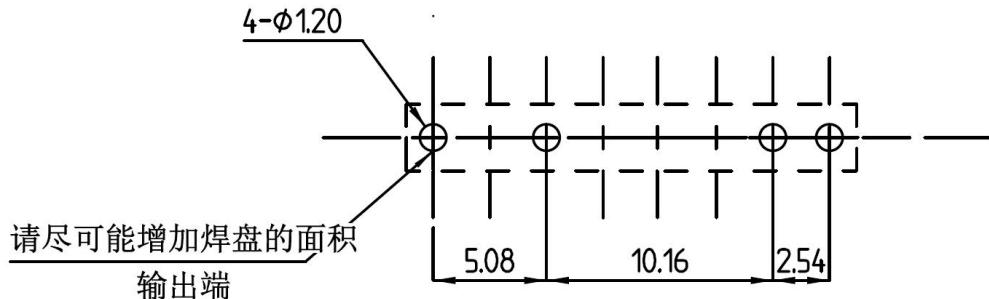


接通和关断时间关系 Turn on and turn off time



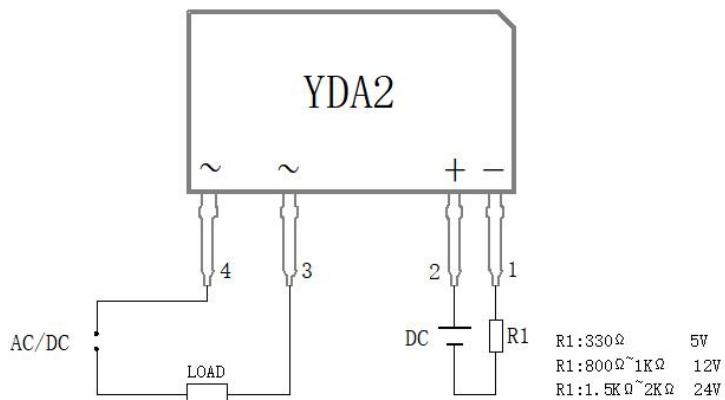
安装孔尺寸图 Fixing layout

Unit:mm



Please enlarge the solder pads of output. 推荐使用散热器 Heatsink is recommended

接线图 Wiring diagram



注意事项 Notes

- 工作环境温度超过 25℃时请降额使用，参见特性曲线 1；推荐使用散热器。
When ambient temperature is above 25°C, the load current must be reduced. (see characteristic data);
Heatsink is recommended.
- 继电器接线时，务必保证输入端极性的正确，以免损坏继电器。
Ensuring the polarity is correct when connecting the input lines, otherwise the wrong connection will damage the relay.

关于防静电对策 Cautions for static electricity

- 操作 MOS 输出继电器的作业人员，请穿戴制电性作业服，通过 $500k\Omega \sim 1M\Omega$ 左右的保护电阻，实施人体接地。Employees handling relays should wear anti-static clothing and should be grounded through protective resistance of $500k\Omega$ to $1M\Omega$.
- 请在作业台上装有带导电性的金属板或具有防静电的专用板，并对测量仪器和治具等实施接地。A conductive metal sheet should be placed over the work table. Measuring instruments and jigs should be grounded.

- c. 使用电烙铁时，对电烙铁前端进行接地。（建议使用低电压用的电烙铁。）When using soldering irons, either use irons with low leakage current, or ground the tip of the soldering iron. (Use of low-voltage soldering irons is also recommended.)
- d. 组装时使用的设备等也应正确的接地。Devices and equipment used in assembly should also be grounded.
- e. 对印刷电路板和机器进行包装时，请避免使用发泡苯乙烯、聚乙烯等带电性的高分子材料。When packing printed circuit boards and equipment, avoid using high-polymer materials such as foam styrene, plastic, and other materials which carry an electrostatic charge.
- f. 对MOS输出继电器进行储存和搬运时，请在不易产生静电的环境(例如湿度45~60%)中通过导电性包装材料进行保护。When storing or transporting relays, the environment should not be conducive to generating static electricity (for instance, the humidity should be between 45 and 60%), and relays should be protected using conductive packing materials.